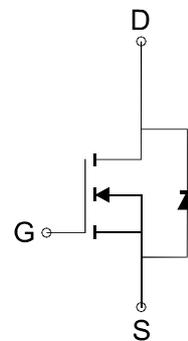
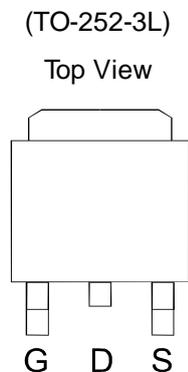


N-Channel 30V (D-S) MOSFET

GENERAL DESCRIPTION

The ME95N03 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as LCD inverter, computer power management and DC to DC converter circuits which need low in-line power loss.

PIN CONFIGURATION



N-Channel MOSFET

FEATURES

- $R_{DS(ON)} \leq 3.2m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} \leq 4.2m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

APPLICATIONS

- Power Management
- DC/DC Converter
- LCD TV & Monitor Display inverter
- CCFL inverter
- Secondary Synchronous Rectification

Ordering Information: ME95N03 (Pb-free)

ME95N03-G (Green product-Halogen free)

Absolute Maximum Ratings (TA=25°C Unless Otherwise Noted)

Parameter	Symbol	Maximum Ratings	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current*	I_D	$T_C=25^\circ C$	100
		$T_C=70^\circ C$	80
Pulsed Drain Current	I_{DM}	400	A
Maximum Power Dissipation	P_D	$T_C=25^\circ C$	54.4
		$T_C=70^\circ C$	34.8
Operating Junction Temperature	T_J	-55 to 150	°C
Thermal Resistance-Junction to Case**	$R_{\theta JC}$	2.3	°C/W

* Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 70A.

** The device mounted on 1in² FR4 board with 2 oz copper.



N-Channel 30V (D-S) MOSFET

Electrical Characteristics (TA=25°C Unless Otherwise Specified)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
STATIC						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1		3	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±20V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	μA
R _{DS(ON)}	Drain-Source On-State Resistance ^a	V _{GS} =10V, I _D = 20A		2.6	3.2	mΩ
		V _{GS} =4.5V, I _D = 20A		3.3	4.2	
V _{SD}	Diode Forward Voltage	I _S =1.0A, V _{GS} =0V		0.6	1.2	V
DYNAMIC						
Q _g	Total Gate Charge	V _{DD} =15V, V _{GS} =10V, I _D =20A		134		nC
Q _g	Total Gate Charge	V _{DD} =15V, V _{GS} =4.5V, I _D =20A		68		
Q _{gs}	Gate-Source Charge			23		
Q _{gd}	Gate-Drain Charge			33		
C _{iss}	Input capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz		6217		pF
C _{oss}	Output Capacitance			855		
C _{rss}	Reverse Transfer Capacitance			304		
t _{d(on)}	Turn-On Delay Time	V _{DS} =15V, V _{GS} =10V, R _G =3Ω, R _L =15Ω I _D =1A		36		ns
t _r	Turn-On Rise Time			23		
t _{d(off)}	Turn-Off Delay Time			126		
t _f	Turn-Off Fall Time			28		

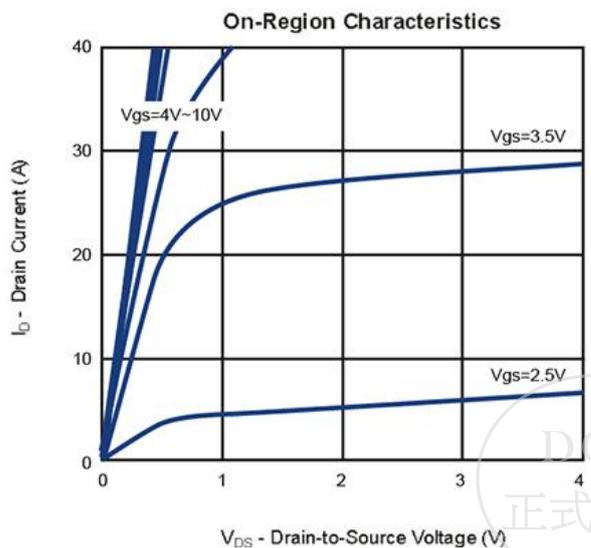
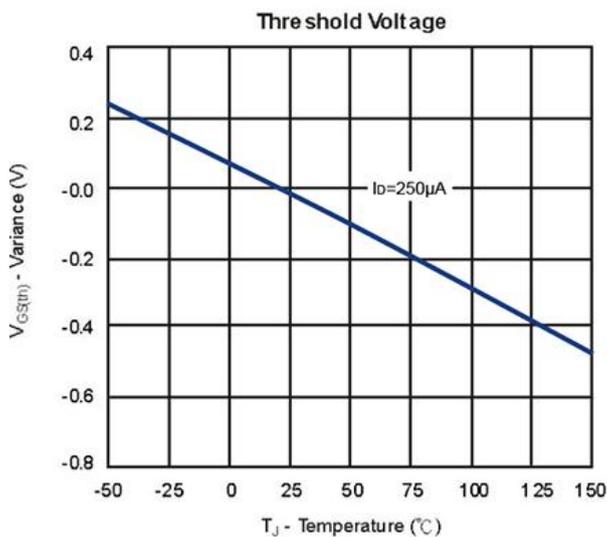
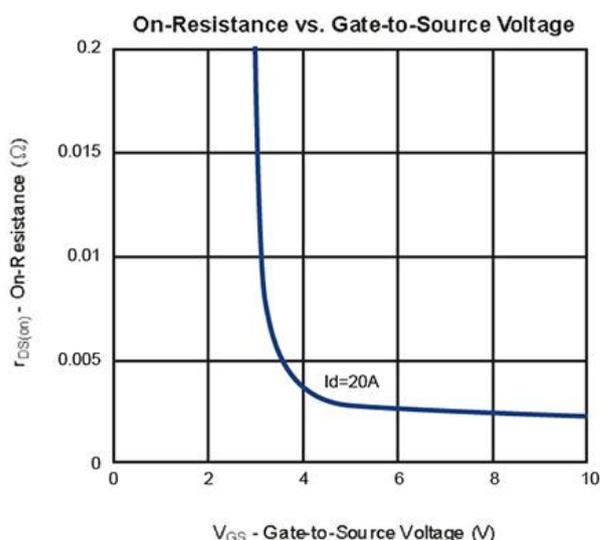
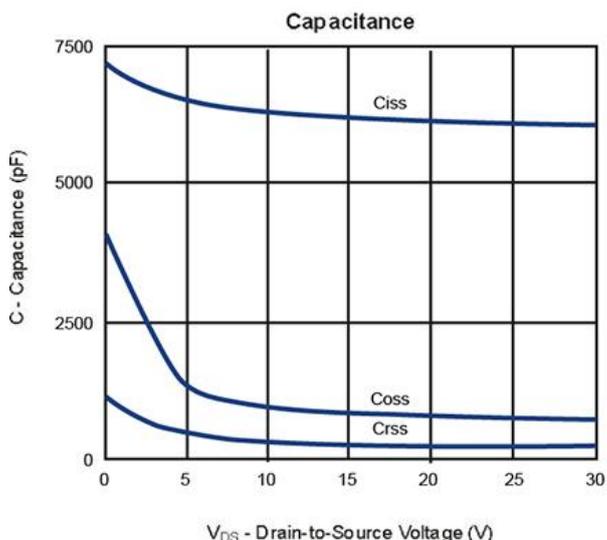
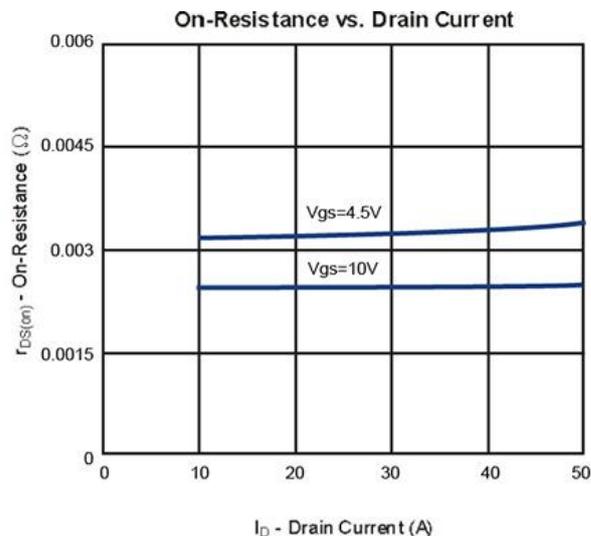
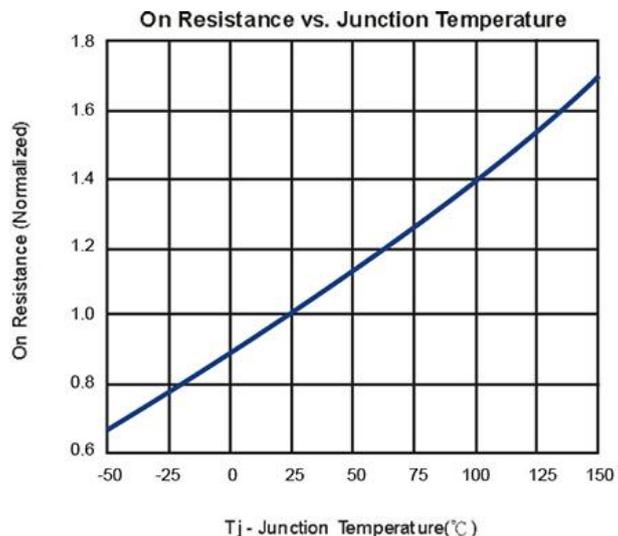
Notes: a. Pulse test: pulse width ≤ 300us, duty cycle ≤ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.

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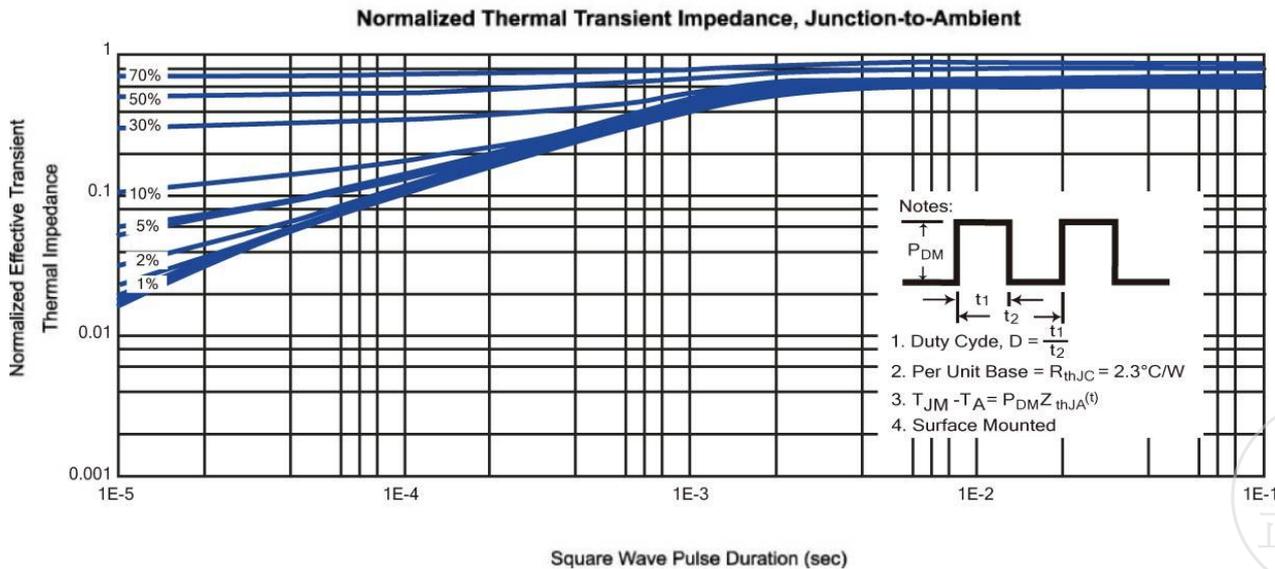
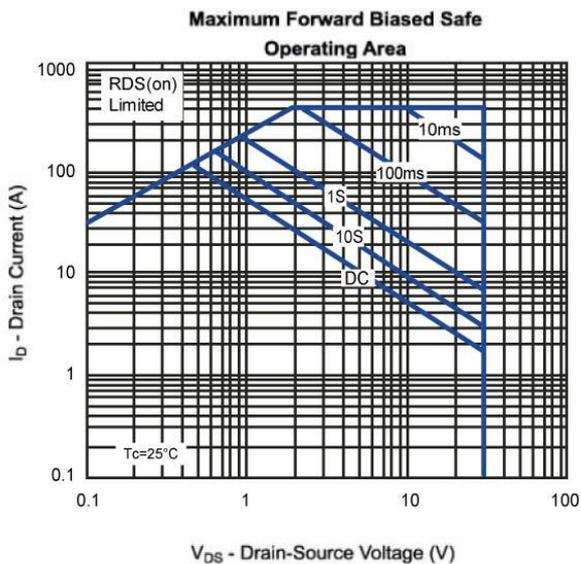
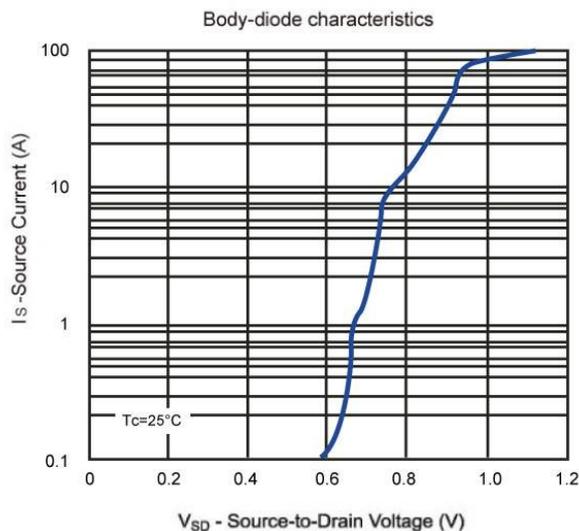
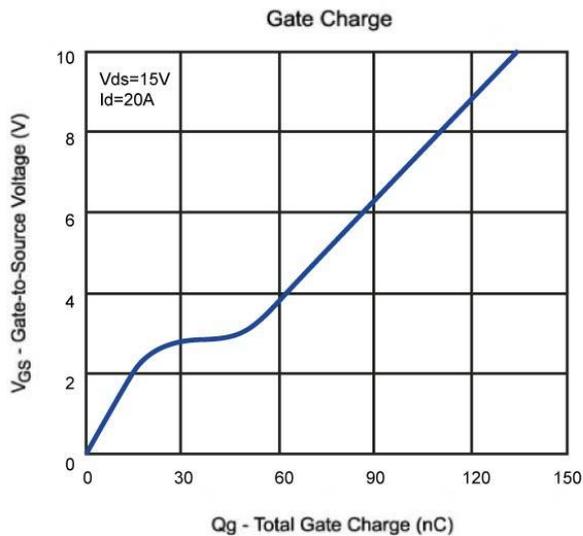
N- Channel 30V (D-S) MOSFET

Typical Characteristics (T_J =25°C Noted)



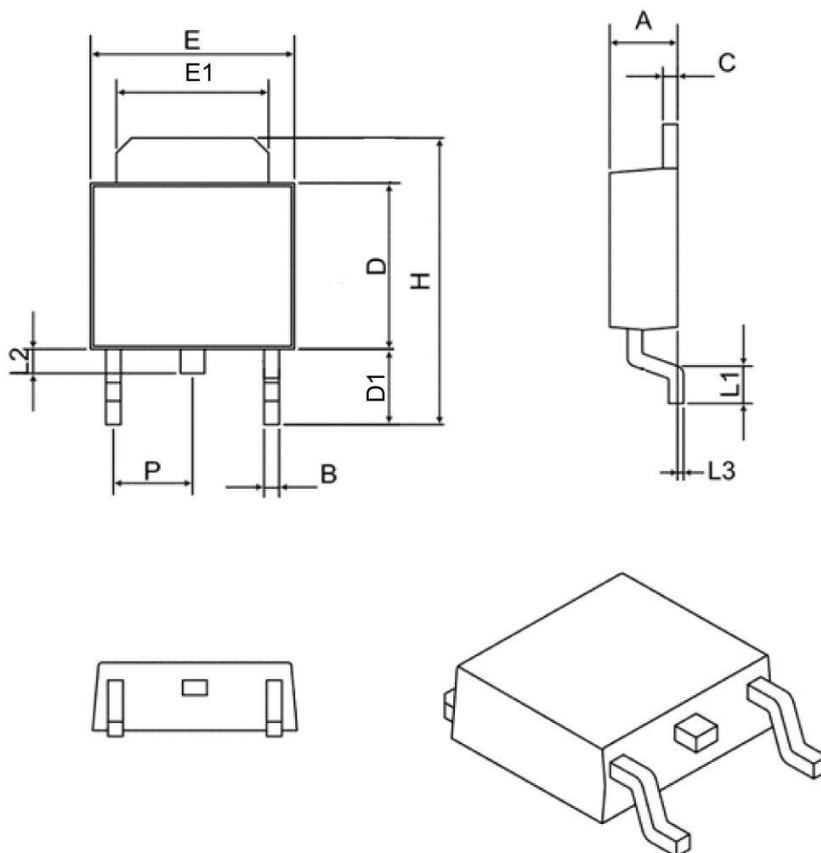
N- Channel 30V (D-S) MOSFET

Typical Characteristics (T_J =25°C Noted)



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TO-252-3L Package Outline



SYMBOL	MIN	MAX
A	2.10	2.50
B	0.40	0.90
C	0.40	0.90
D	5.30	6.30
D1	2.20	2.90
E	6.30	6.75
E1	4.80	5.50
L1	0.90	1.80
L2	0.50	1.10
L3	0.00	0.20
H	8.90	10.40
P	2.30 BSC	

